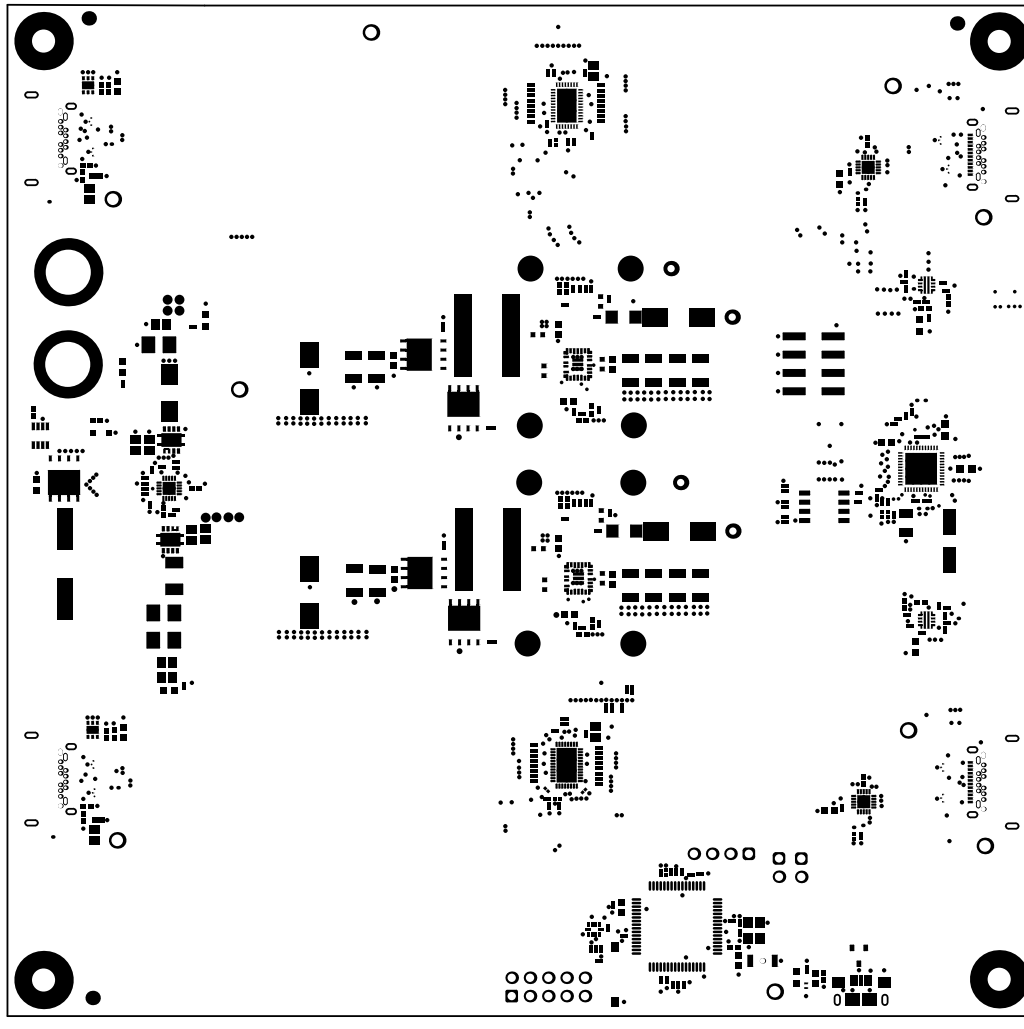
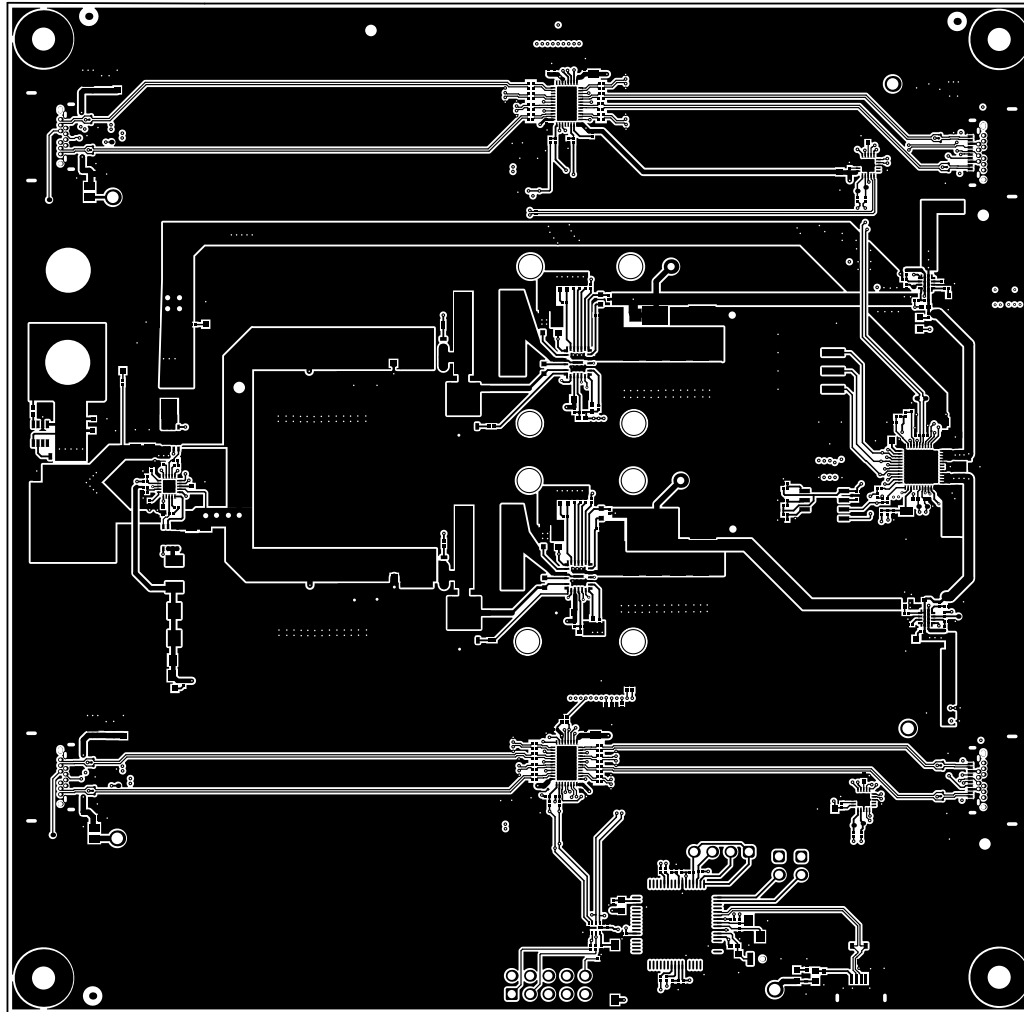


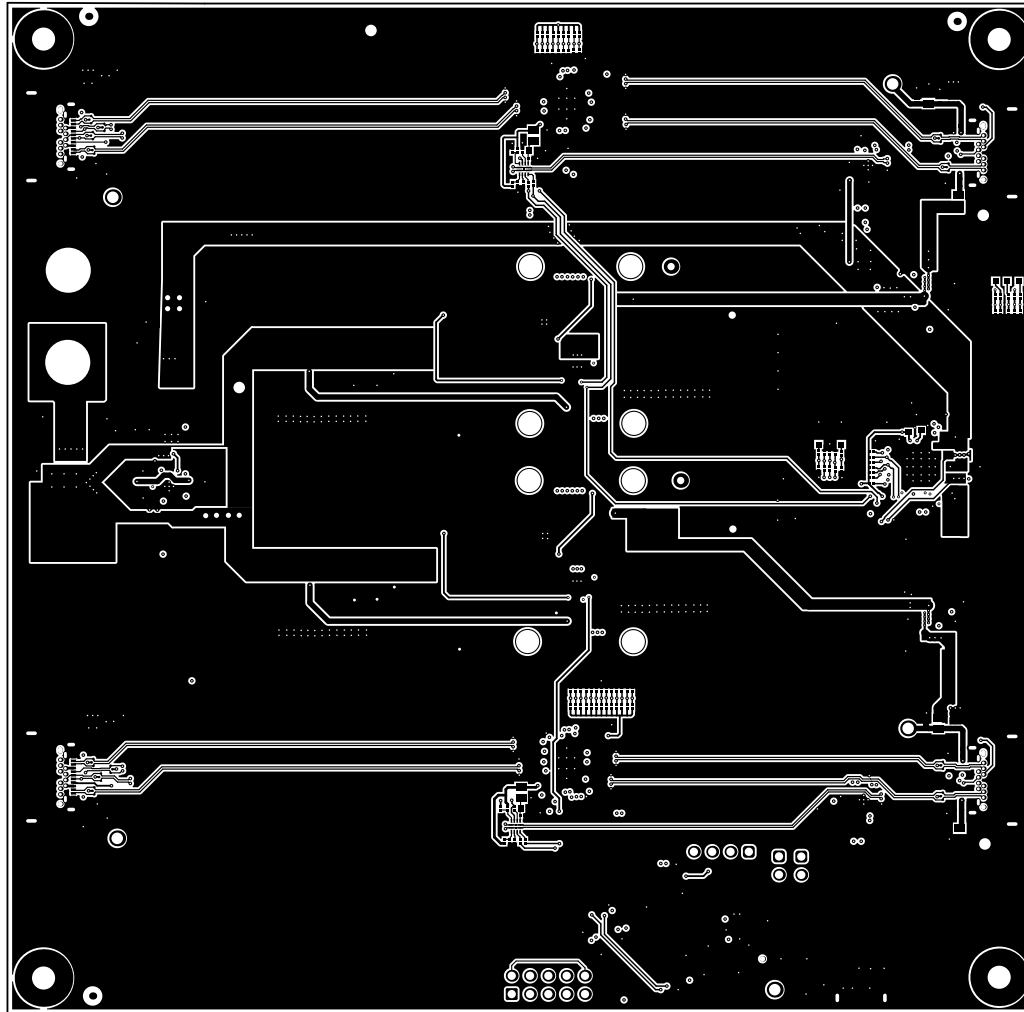
ALL artwork viewed from TOP SIDE	BOARD #: ISFA-375	REV: E2	SUN REV: 14568 [Locally Modified]
LAYER NAME = Top Overlay	TID #: TIDA-010248		
PLOT NAME = Top Overlay	GENERATED : 2/17/2023 5:31:41 PM	TEXAS INSTRUMENTS	



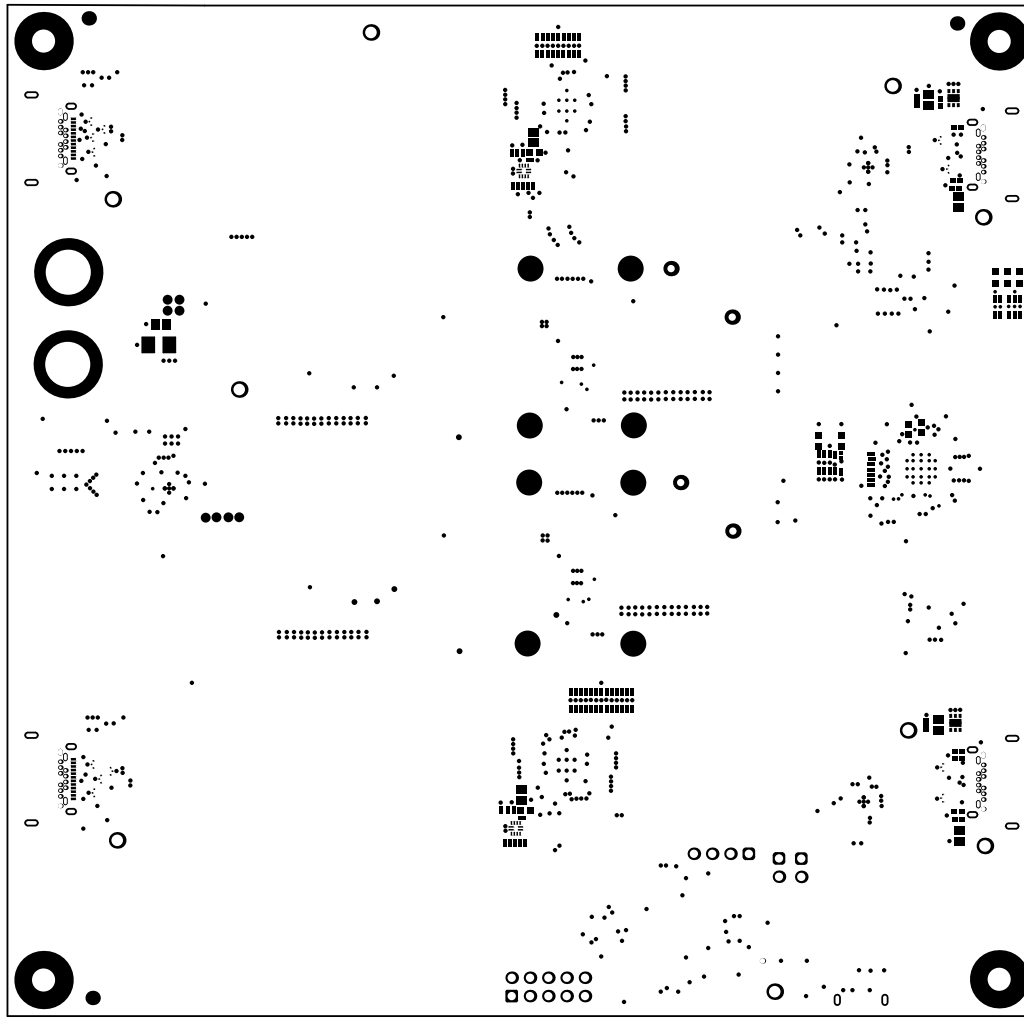
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISFA-375	REV: E2	SUN REV: 14568 [Locally Modified]
LAYER NAME = Top Solder	TID #: TIDA-010248		
PLOT NAME = Top Solder Mask	GENERATED : 2/17/2023	5:31:41 PM	TEXAS INSTRUMENTS



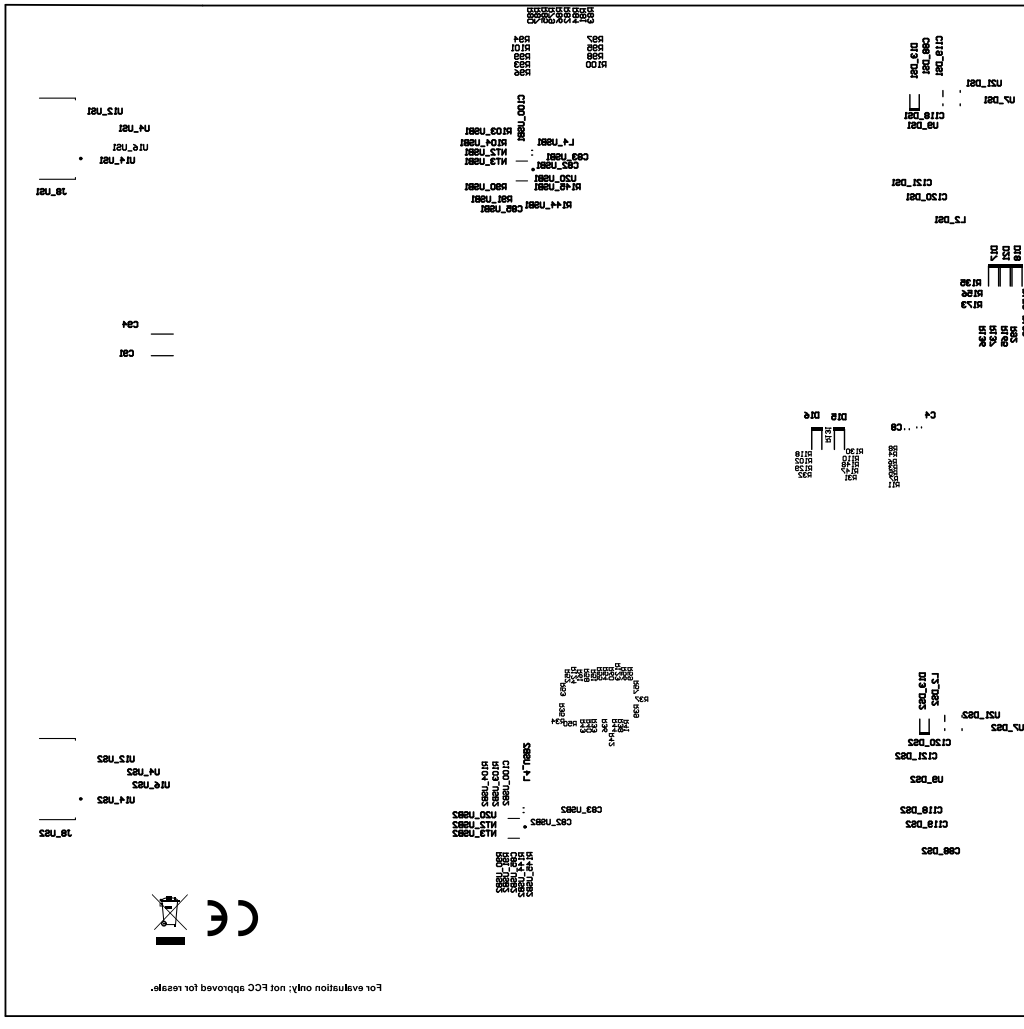
ALL artwork viewed from TOP SIDE	BOARD #:	ISFA-375	REV:	E2	SUN REV:	14568 [Locally Modified]
LAYER NAME =	Top_SL	TID #:	TIDA-010248			
PLOT NAME =	Top Layer	GENERATED :	2/17/2023	5:31:42 PM	TEXAS INSTRUMENTS	



ALL artwork viewed from TOP SIDE	BOARD #: ISFA-375	REV: E2	SUN REV: 14568 [Locally Modified]
LAYER NAME = Bottom_SL	TID #: TIDA-010248		
PLOT NAME = Bottom Layer	GENERATED : 2/17/2023 5:31:42 PM	TEXAS INSTRUMENTS	



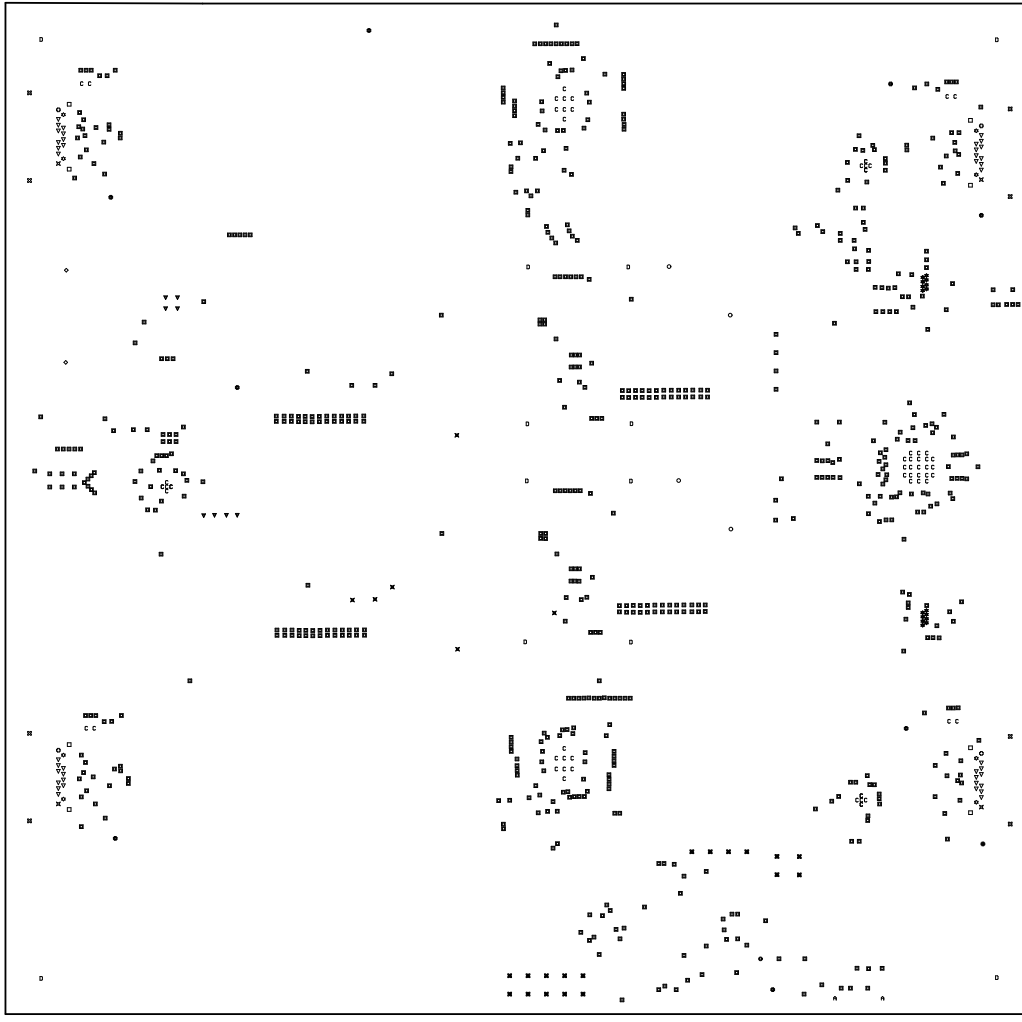
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LAYER NAME = Bottom Solder	TID #: TIDA-010248		
PLOT NAME = Bottom Solder Mask	GENERATED : 2/17/2023 5:31:42 PM	TEXAS INSTRUMENTS	



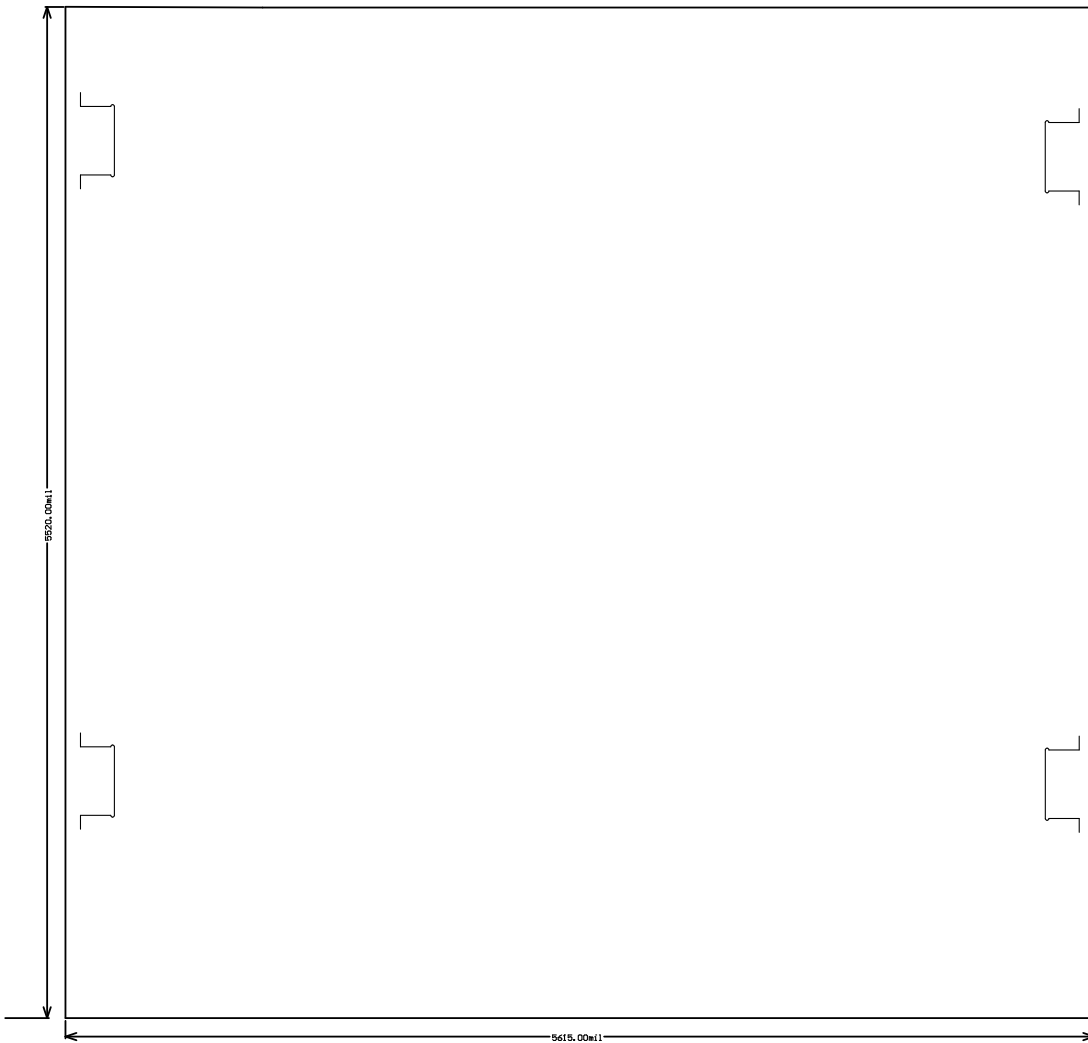
ALL artwork viewed FROM TOP SIDE	BOARD #: ISFA-375	REV: E2	SUN REV: 14568 [Locally Modified]
LAYER NAME = Bottom Overlay	TID #: TIDA-010248		
PLOT NAME = Bottom Overlay	GENERATED : 2/17/2023 5:31:42 PM	TEXAS INSTRUMENTS	

Symbol	Quantity	Finished Hole Size	Plating	Plate Type	Drill Layer Pair	Min. Tolerance
X	1	15.8984 (0.6256)	None	Round	TopCu - BottomCu	
●	1	28.5844 (1.1253)	M7H	Round	TopCu - BottomCu	
●	16	1.5194 (0.0598)	PTH	Round	TopCu - BottomCu	
●	68	1.0178 (0.0399)	PTH	Round	TopCu - BottomCu	
C	68	1.0178 (0.0399)	PTH	Round	TopCu - BottomCu	
○	68	1.0178 (0.0399)	PTH	Round	TopCu - BottomCu	
○	68	1.0178 (0.0399)	PTH	Round	TopCu - BottomCu	
V	6	16.0000 (0.6250)	PTH	Round	TopCu - BottomCu	
V	6	16.0000 (0.6250)	PTH	Round	TopCu - BottomCu	
V	6	16.0000 (0.6250)	PTH	Round	TopCu - BottomCu	
V	6	16.0000 (0.6250)	PTH	Round	TopCu - BottomCu	
●	18	0.2109 (0.0083)	PTH	Round	TopCu - BottomCu	
●	9	0.2109 (0.0083)	PTH	Round	TopCu - BottomCu	
●	12	1.0254 (0.0403)	PTH	Round	TopCu - BottomCu	
○	2	1.6826 (0.0662)	PTH	Round	TopCu - BottomCu	
○	1	2.1309 (0.0839)	M7H	Blk	TopCu - BottomCu	
○	9	1.0254 (0.0403)	PTH	Blk	TopCu - BottomCu	
A	2	1.0254 (0.0403)	PTH	Blk	TopCu - BottomCu	
□	9	0.2109 (0.0083)	PTH	Blk	TopCu - BottomCu	
□	9	0.2109 (0.0083)	PTH	Blk	TopCu - BottomCu	
DRY HOLE						

Reference: 2021 Layer 10 (Bottom PCB Layer) - Top Cu - 128 Layers or More in the PCB Stack



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISFA-375	REV: E2	SUN REV: 14568 [Locally Modified]
LAYER NAME = Drill Drawing	TID #: TIDA-010248		
PLOT NAME = Drill Drawing	GENERATED : 2/17/2023 5:31:43 PM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISFA-375	REV: E2	SUN REV: 14568 [Locally Modified]
LAYER NAME = M2 Board Dimensions	TID #: TIDA-010248		
PLOT NAME = Board Dimensions	GENERATED : 2/17/2023	5:31:44 PM	TEXAS INSTRUMENTS



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